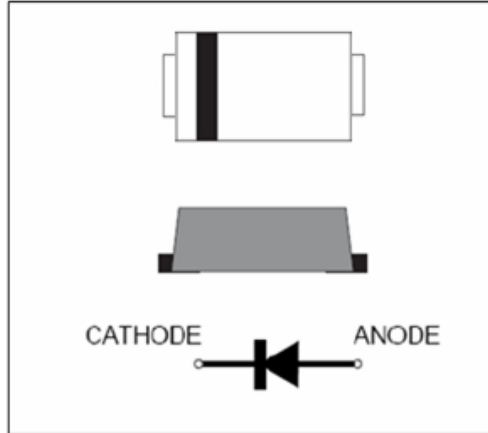


# FFMAF207L

## Surface Mount Glass Passivated Junction Fast Recovery Rectifiers Reverse Voltage 1000V Forward Current 2.0A

### FEATURES

- \* Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- \* High temperature metallurgically bonded construction
- \* Cavity-free glass passivated junction
- \* Capable of meeting environmental standards of MIL-S-19500
- \* Typical IR less than 1.0 $\mu$ A
- \* High temperature soldering guaranteed: 260°C/10 seconds



We declare that the material of product is Halogen free (green epoxy compound)

### Mechanical Data

**Case:** JEDEC SMA-FL, molded plastic over glass DIE

**Terminals:** Plated leads, solderable per MIL-STD-750, Method 2026

**Polarity:** Color band denotes cathode end

**Mounting Position** Any

**Weight:** 0.0327g

**Handling precaution:** None

### Electrical Characteristic

#### 1. Maximum & Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter Symbol	symbol	FFMAF 207L	Unit
Device marking code		FF27L	
Maximum repetitive peak reverse voltage	$V_{RRM}$	1000	V
Maximum RMS voltage	$V_{RMS}$	700	V
Maximum DC blocking voltage	$V_{DC}$	1000	V
Maximum average forward rectified current lead length at $T_c = 75^\circ\text{C}$ (Note 2)	$I_{F(AV)}$	2.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	60	A
Typical reverse recovery time (Note 1)	$t_{rr}$	480	ns
Typical thermal resistance (Note 2)	$R_{\theta JA}$ $R_{\theta Jc}$	150 25	$^\circ\text{C/W}$
Operating junction temperature range	$T_J$	-55 to +150	$^\circ\text{C}$
storage temperature range	$T_{STG}$	-65 to +175	$^\circ\text{C}$

#### Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter Symbol	symbol	FFMAF207L	Unit
Maximum instantaneous forward voltage at 2.0A	$V_F$	1.05	V
Maximum DC reverse current $T_J = 25^\circ\text{C}$ at rated DC blocking voltage $T_J = 125^\circ\text{C}$	$I_R$	5.0 100	$\mu\text{A}$
Typical junction capacitance at 4.0V, 1MHz (Note 2)	$C_J$	15.0	PF

#### NOTES:

1.  $I_F = 0.5\text{A}$ ,  $I_R = 1.0\text{A}$ ,  $IRR = 0.25\text{A}$
2.  $8.0\text{mm}^2$  (.013mm thick) land areas

# FFMAF207L

## 2. Characteristic Curves ( TA = 25°C unless otherwise noted )

Fig. 1 - Forward Current Derating Curve

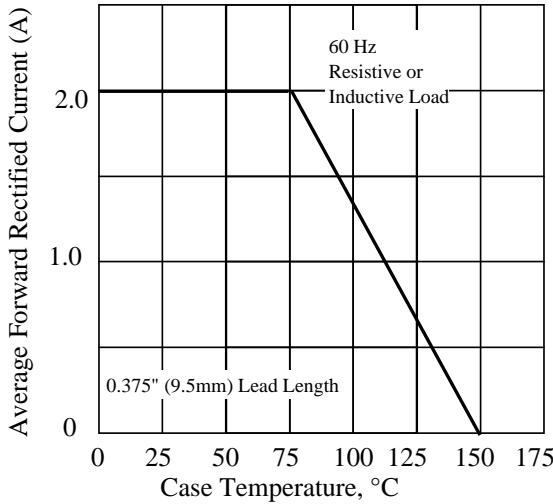


Fig. 2 - Maximum Non-repetitive Peak Forward Surge Current

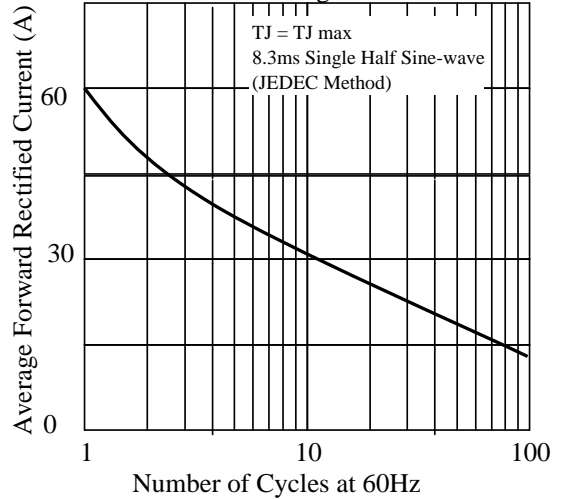


Fig 3. - Typical Instantaneous Forward Characteristics

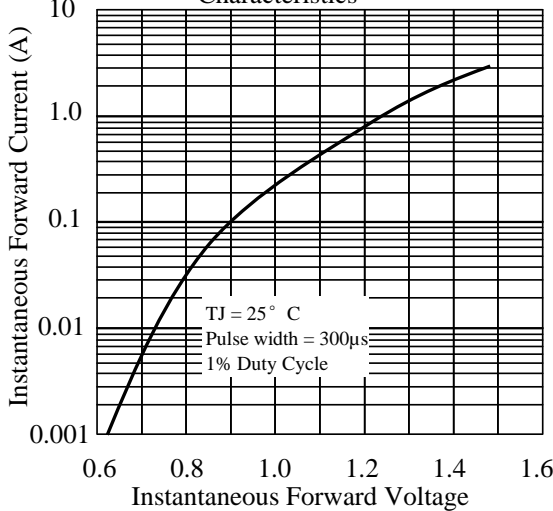


Fig 4. - Typical Reverse Characteristics

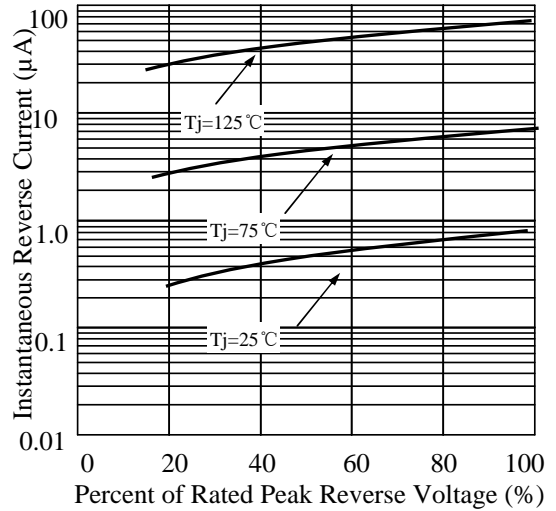


Fig 5. - typical transient thermal impedance

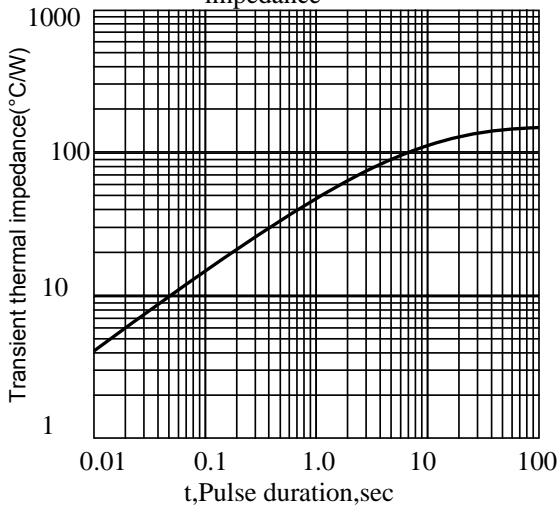
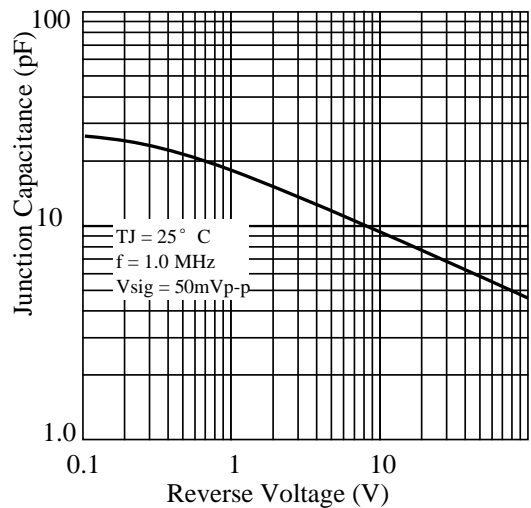


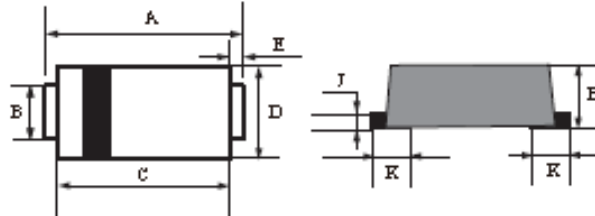
Fig 6. - Typical Junction Capacitance



## FFMAF207L

### 3. dimension:

SMA-FL

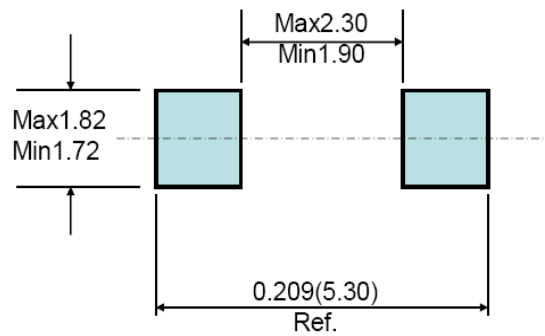


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.4	4.8	0.173	0.189
B	1.3	1.5	0.051	0.059
C	3.3	3.7	0.130	0.146
D	2.3	2.7	0.091	0.106
E	0.90Typ		0.035Typ	
H	0.9	1.2	0.036	0.047
J	0.11	0.21	0.005	0.009

Suggested solder pad layout

Mounting Pad Layout

SMA-FL



5.1 、 SMD Packing Reel Spec & Packing Quantity

5.1.1 Reel Packing

A. Reel Spec



unit: mm

SPEC	A	B	C	W	Quantity/Reel
SMA-FL 7" reel	177.0±2.0	54.0±0.5	13.0±0.5	13.2±0.2	3K
TO277 13" reel	330.0±2.0	75.0±0.5	13.0±0.5	13.2±0.2	5K
SOD123FL 7" reel	177.0±2.0	50.0±0.5	13.0±0.5	9.4±1.5	3K
SOD323HE 7" reel	177.0±2.0	50.0±0.5	13.0±0.5	9.4±1.5	3K
SMB-FL 13" reel	330.0±2.0	75.0±0.5	13.0±0.5	13.2±0.2	5K

B. 13" reel packing box



unit: mm

size	A	B	C
	335±5.0	335±2.0	40±1.0

as per above packing

Spec	Q' ty/Box
TO277 13" reel	10K
SMB-FL 13" reel	10K

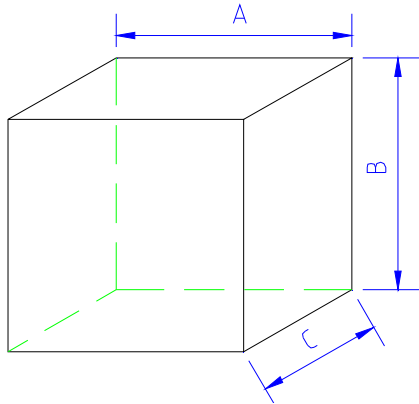
Title:  
Power Diode SMD Package Packing Spec

DOC NO.: WI-258

DOC NO.: WI-258

Page: 3

C. 7" reel packing box



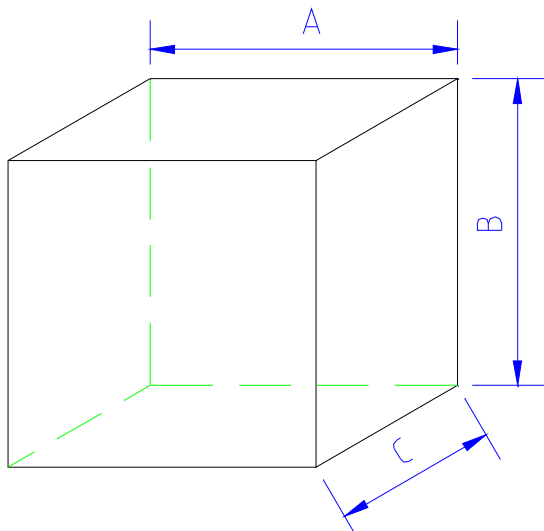
unit: mm

	A	B	C
SMA-FL			
SOD123FL			
SOD323HE	186±2.0	139±2.0	185±2.0

as per above packing

	Q' ty/Box
SMA-FL	30K
SOD123FL	30K
SOD323HE	30K

D. reel packing carton



unit: mm

	A	B	C
size	350±2.0	340±2.0	350±2.0

as per above packing

Spec	Q' ty/Carton
TO277 13" reel	80K
SMB-FL 13" reel	80K

unit: mm

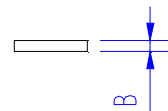
	A	B	C
SMA-FL			
SOD123FL			
SOD323HE	455±2.0	400±2.0	410±2.0

as per above packing

Spec	Q' ty/Carton
SMA-FL 7" reel	360K
SOD123-FL 7" reel	360K
SOD323HE 7" reel	360K

5.1.2 Tape Spec

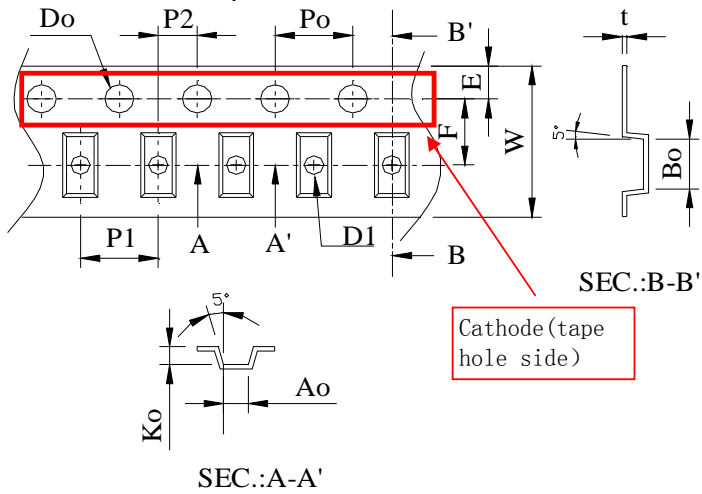
A. Cover Tape



unit: mm

	A	B
SMA-FL	9.5±0.10	0.062±0.007
SMB-FL		
TO277		
SOD123FL	5.4±0.10	
SOD323HE		

**B. Carrier Tape**



Item	SOD323HE	SOD123FL	SMA-FL	SMB-FL	TO277
W	8±0.3	8±0.3	12±0.3	12±0.3	12±0.3
P1	4±0.1	4±0.1	4±0.1	8±0.1	8±0.1
E	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1
F	3.5±0.05	3.5±0.05	5.5±0.05	5.5±0.05	5.5±0.05
D0	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05
D1	1.1±0.1	1.1±0.1	1.5±0.1	1.55±0.05	1.5±0.1
P0	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1
P2	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05
10P0	40±0.2	40±0.2	40±0.2	40±0.2	40±0.2
A0	1.45±0.1	1.95±0.1	2.83±0.1	3.8±0.1	4.3±0.1
B0	2.75±0.1	3.95±0.1	4.75±0.1	5.75±0.1	6.8±0.1
K0	0.80±0.1	1.30±0.1	1.42±0.1	1.4±0.1	1.35±0.1
T	0.25±0.05	0.25±0.05	0.25±0.05	0.25±0.05	0.25±0.05

Title:

Power Diode SMD Package Packing Spec

DOC NO.: WI-258

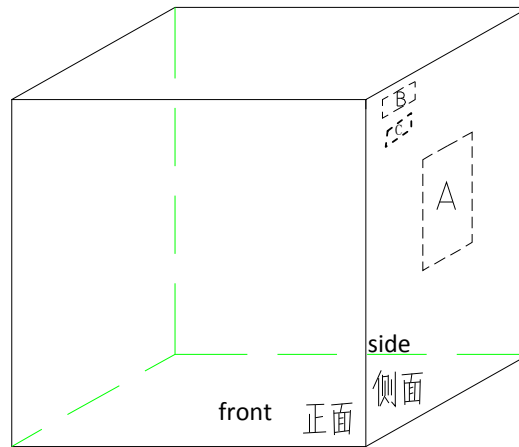
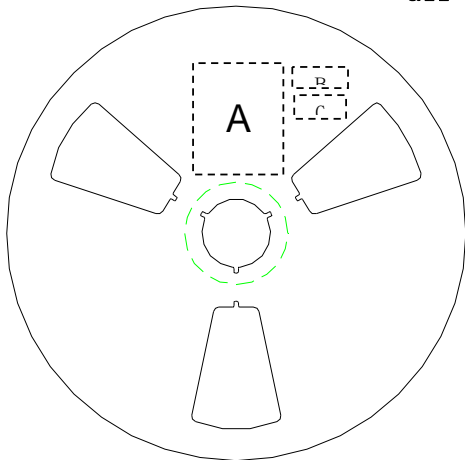
Version: 5 Modification: 0

Page: 5

5.2、SMD Power Diode General Packing Spec

A. 7" reel

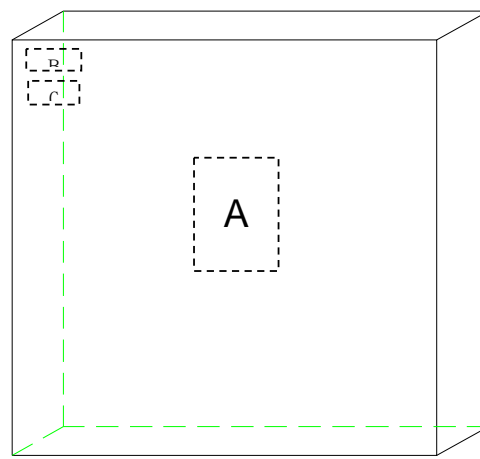
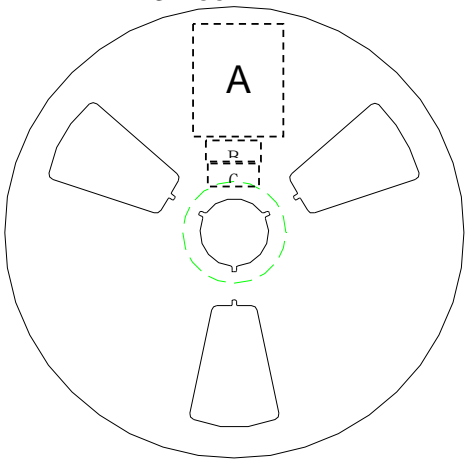
all labels will be at cathode side of reel ;



A:LRC label;

B:Environment Label C:Halide free label

B. 13" reel



A:LRC label;

B:Environment Labe C:Halide free label

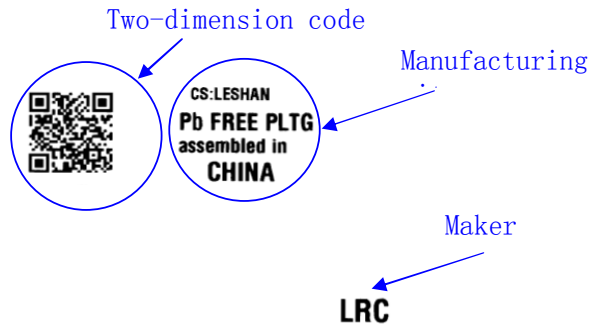
C. Tape lead: face anode side of the reel, upper side is the tape lead position. All labels are at cathode side of the reel.



标题: <b>Power Diode SMD Package Packing Spec</b>	DOC NO.: WI-258
	Version: 5    Modification: 0
	Page: 6

C. Label Content :  
LRC Label

P/N → (1P) LPN: **SM140A**  
 Lot No. → (1T) LOT: **140106049X**  
 Date code → (9D) DTE: **1403**  
 Quantity → (Q) QTY: **10000**



lot: 140106049X: 140106---2014/1/6; 049----lot number:49; X: product code

Environment Label



Halide-free Label





## FFMAF207L

### 4. Update Record

版次	更新记录	更新作者	更新日期
1	第一版	周杰	2014. 04. 25

单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)